IF YOU USE MEMORIES

–DON'T FORGET US

Booths 417, 419, 421
FALL JOINT COMPUTER CONFERENCE
OCT. 27-29, 1964
SAN FRANCISCO, CALIFORNIA

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- [x] Integrated, plug-in memory system
- [ ] One-microsecond, coincident-current memory system
- [ ] 18.9 million-bit memory
- [ ] Planes and stacks
- [ ] Modular thin-film system components
- [ ] Two-microsecond memory systems
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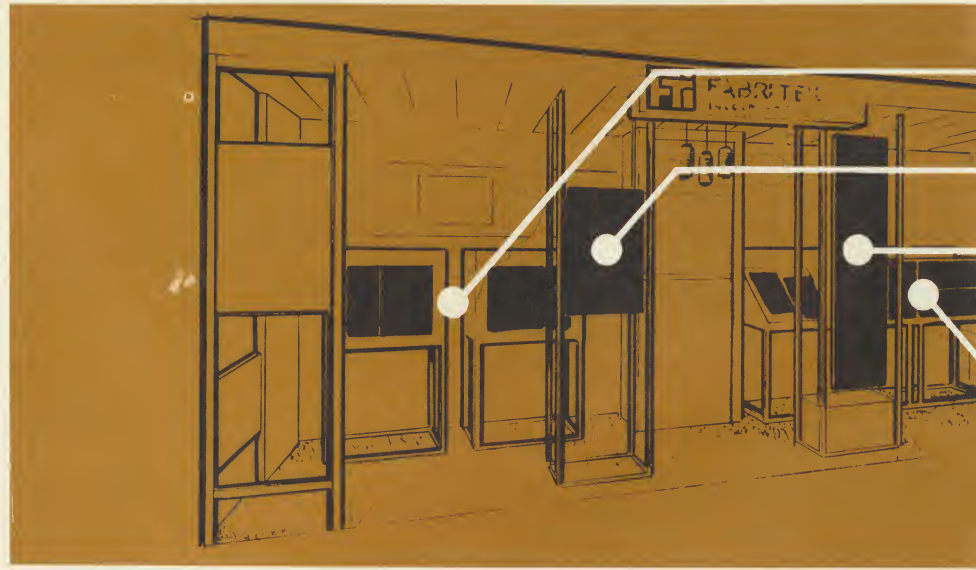

Integrated circuit, plug-in memory system

One-microsecond, coincident-current memory system

18.9 million-bit mass memory

Planes and stacks

Modular thin-film system components

Here's our exhibit—Booths 417, 419, 421—FJCC
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Integrated Memory System—This exceptionally low-cost, plug-in system contains the "heart" of a complete memory system, with stack, drivers, selection circuits, and sense amplifiers packaged in one compact unit. Integrated circuits are selected to match the same components used in the customer's equipment to keep logic levels identical.

One-microsecond Coincident-Current Memory System—Features all silicon semi-conductors and component economies prevalent with the coincident-current memory organization. Wide operational margins make this system very reliable, even in large capacities up to 1,500,000 bits.

18.9 Million-bit Memory—The new mass memory concept to be illustrated at FJCC provides mass memory frames measuring 5′ long by 13″ wide to be arranged in "window frame" stacks having 18.9 million bit capacities. The stacks and associated electronics are packaged in 6′ square by 2′ wide modular cabinets to enable a mass memory of any size to be easily assembled.

Planes and Stacks—Fabri-Tek is a leading manufacturer of core memory planes and stacks. A variety of stack packaging types and sizes are available for any plane or stack requirement. Fabri-Tek incorporates the latest advances in core dimensions and performance available to the memory industry.

Modular Thin-film System Components — The standard production 150 nsec access time FFM-202 Thin-film Memory System has been divided into a choice of three modules. Stack alone, stack with basic electronics, and complete system are now available to give systems designers a freedom of choice as to the level of thin-film memory complexity they can build-or-buy.